

NEXCOM International Co., Ltd.

Mobile Computing Solutions Vehicle Telematics Computer VTC 1010 User Manual

NEXCOM International Co., Ltd. Published October 2015

www.nexcom.com



Contents

Preface

Copyright	V
Disclaimer	V
Acknowledgements	v
Regulatory Compliance Statements	v
Declaration of Conformity	v
RoHS Compliance	vi
Warranty and RMAv	
Technical Support and Assistance	х
Conventions Used in this Manual	х
Global Service Contact Information	хi
Package Contentsxi	ii

Chapter 1: Product Introduction

Physical Features	1
Front View	1
Rear View	1
Overview	2
Key Features	2
Hardware Specifications	3
Connector Numbering	

Chapter 2: External Connectors Pinout Description

LED Indicators (PWR, Status, LAN & GPIO)6
LED Indicators (SSD, GPS, WLAN & WWAN)6

USB 3.0 Port	7
Audio Jack 3.5mm	7
SD Card Connector	8
SIM1 Socket	8
SIM2 Socket	9
Event Button	9
Reset Button	10
Power Input	10
Multiport Connector	11
VGA Connector	12
RS232 Connector	12
Line-out	13
Mic-in	
DisplayPort	14
USB 2.0 Port	14
LAN Connector	15

Chapter 3: Jumpers and Switches

Before You Begin	16
Precautions	16
Jumper Settings	17
VTC 1010 Jumper and Switch Settings	19
CMOS Clear Switch	19
Voltage Selector (For CN10 Connector)	19
WWAN Module Selector (For Wake-Up & Voice on CN10)	20
RTC Battery Connector	20



External Thermal Sensor Module	21
Debug 80 Port Connector	21
VGA Connector	22
COM Port Connector	
High Speed UART Connector	23
OBDII Module Connector	
Capture Card Connector	24
Capture Card Connector	24
5V Output	25
Event Button Connector	25
SATA HDD Connector	26
MCU Debug Port	26
GAL Download Port	27
MCU Download Port	27
GPIO Setting	28
Voltage Setup Selection	28
FAN Connector	29
VIOB-GPS-DR01	29
GPS Module Connector	
MCU GPIO Connector	
PCIe Connector	31
Expand Connector	31
Mini-PCIe (USB + PCIe)	32
Mini-PCIe (mSATA or PCIe [default])	33
Mini-PCIe (USB + PCIe)	34
Mini-PCIe (USB)	35

Chapter 4: Mechanical	Dimensions36
------------------------------	--------------

Chapter 5: System Setup

NE(COM

Removing the Chassis Cover	7
Installing the First WWAN Module	8

40
42
45
45

Appendix A: Software Demo Utility for I/O Ports of Function Control

Menu Screen	46
1.1 Status	47
1.2 GPIO Setting	48
1.3 MCU GPIO Setting	
1.4 WDT Setting	49
1.5 3G Module	49
1.6 RS-422/RS-485	50
1.7 Power On Delay Time	50
1.8 Power Off Delay Time	50
1.9 Wake Up Function	51
2.0 Mini-PCIe Module Power On/Off	51
2.1 CAN Bus Setting	52

Appendix B: GPS Feature

uBlox-NEO M8 Overview	53
Technical Specifications	53

Appendix C: Pin Definition for the Multiport Cable

P1 Connector Pinout	56
P2 to P17 Connector Pinouts	56
Power Output Connector	56
RS232 Connector	56
GPIO + CAN Bus 2.0B Connector	57
OBDII Connector	57



USB Connector	
RS422/485 Connector	
Reset Button	59
Odometer Connector	59
A/V1 Jack	60
A/V2 Jack	60
A/V3 Jack	61
A/V4 Jack	61
Front Audio	62
Center Audio	62
Surround Audio	63
Rear Audio	63

Appendix D: Signal Connection of DI/DO

GPIO Pinout Description	64
SW1 Setting	
Digital Input	65
Digital Output	66

Appendix E: Vehicle Power Management Setup

External Power Output Setting	.67
Startup and Shutdown Voltage Setting	.67
Power-on Delay Setting	.69
Power-off Delay Setting	.71

Appendix F: Power Consumption......73



Preface

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Acknowledgements

VTC 1010 is a trademark of NEXCOM International Co., Ltd. All other product names mentioned herein are registered trademarks of their respective owners.

Regulatory Compliance Statements

This section provides the FCC compliance statement for Class B devices and describes how to keep the system CE compliant.

Declaration of Conformity

FCC

This equipment has been tested and verified to comply with the limits for a Class B digital device, pursuant to Part 15 of FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. Operation of this equipment in a residential area (domestic environment) is likely to cause harmful interference, in which case the user will be required to correct the interference (take adequate measures) at their own expense.

CE

The product(s) described in this manual complies with all applicable European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques.



e13 Mark

The "e" mark is the proof of compliance with directives (laws) required by the European Union. The Council of European communities in Brussels issues these directives and all members must accept approved products.

e13 - Luxembourg

For more information, visit http://www.tuv.com/jp/en/_e_mark_and_e_mark_homologation_for_vehicles_vehicle_components_.html.

RoHS Compliance



NEXCOM RoHS Environmental Policy and Status Update

NEXCOM is a global citizen for building the digital infrastructure. We are committed to providing green products and services, which are compliant with

European Union RoHS (Restriction on Use of Hazardous Substance in Electronic Equipment) directive 2011/65/EU, to be your trusted green partner and to protect our environment.

RoHS restricts the use of Lead (Pb) < 0.1% or 1,000ppm, Mercury (Hg) < 0.1% or 1,000ppm, Cadmium (Cd) < 0.01% or 100ppm, Hexavalent Chromium (Cr6+) < 0.1% or 1,000ppm, Polybrominated biphenyls (PBB) < 0.1% or 1,000ppm, and Polybrominated diphenyl Ethers (PBDE) < 0.1% or 1,000ppm.

In order to meet the RoHS compliant directives, NEXCOM has established an engineering and manufacturing task force in to implement the introduction of green products. The task force will ensure that we follow the standard NEXCOM development procedure and that all the new RoHS components and new manufacturing processes maintain the highest industry quality levels for which NEXCOM are renowned.

How to recognize NEXCOM RoHS Products?

For existing products where there are non-RoHS and RoHS versions, the suffix "(LF)" will be added to the compliant product name. All new product models launched after January 2013 will be RoHS compliant. They will use the usual NEXCOM naming convention.



Warranty and RMA

NEXCOM Warranty Period

NEXCOM manufactures products that are new or equivalent to new in accordance with industry standard. NEXCOM warrants that products will be free from defect in material and workmanship for 2 years, beginning on the date of invoice by NEXCOM. HCP series products (Blade Server) which are manufactured by NEXCOM are covered by a three year warranty period.

NEXCOM Return Merchandise Authorization (RMA)

- Customers shall enclose the "NEXCOM RMA Service Form" with the returned packages.
- Customers must collect all the information about the problems encountered and note anything abnormal or, print out any on-screen messages, and describe the problems on the "NEXCOM RMA Service Form" for the RMA number apply process.
- Customers can send back the faulty products with or without accessories (manuals, cable, etc.) and any components from the card, such as CPU and RAM. If the components were suspected as part of the problems, please note clearly which components are included. Otherwise, NEXCOM is not responsible for the devices/parts.
- Customers are responsible for the safe packaging of defective products, making sure it is durable enough to be resistant against further damage and deterioration during transportation. In case of damages occurred during transportation, the repair is treated as "Out of Warranty."
- Any products returned by NEXCOM to other locations besides the customers' site will bear an extra charge and will be billed to the customer.

Repair Service Charges for Out-of-Warranty Products

NEXCOM will charge for out-of-warranty products in two categories, one is basic diagnostic fee and another is component (product) fee.

System Level

- Component fee: NEXCOM will only charge for main components such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistor, capacitor.
- Items will be replaced with NEXCOM products if the original one cannot be repaired. Ex: motherboard, power supply, etc.
- Replace with 3rd party products if needed.
- If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

Board Level

- Component fee: NEXCOM will only charge for main components, such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistors, capacitors.
- If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

vii



Warnings

Read and adhere to all warnings, cautions, and notices in this guide and the documentation supplied with the chassis, power supply, and accessory modules. If the instructions for the chassis and power supply are inconsistent with these instructions or the instructions for accessory modules, contact the supplier to find out how you can ensure that your computer meets safety and regulatory requirements.

Cautions

Electrostatic discharge (ESD) can damage system components. Do the described procedures only at an ESD workstation. If no such station is available, you can provide some ESD protection by wearing an antistatic wrist strap and attaching it to a metal part of the computer chassis.

Safety Information

Before installing and using the device, note the following precautions:

- Read all instructions carefully.
- Do not place the unit on an unstable surface, cart, or stand.
- Follow all warnings and cautions in this manual.
- When replacing parts, ensure that your service technician uses parts specified by the manufacturer.
- Avoid using the system near water, in direct sunlight, or near a heating device.
- The load of the system unit does not solely rely for support from the rackmounts located on the sides. Firm support from the bottom is highly necessary in order to provide balance stability.
- The computer is provided with a battery-powered real-time clock circuit. There is a danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.

Installation Recommendations

Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.

Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:

- A Philips screwdriver
- A flat-tipped screwdriver
- A grounding strap
- An anti-static pad

Using your fingers can disconnect most of the connections. It is recommended that you do not use needlenose pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.



Safety Precautions

- Read these safety instructions carefully.
- Keep this User Manual for later reference.
- Disconnect this equipment from any AC outlet before cleaning. Use a damp cloth. Do not use liquid or spray detergents for cleaning.
- For plug-in equipment, the power outlet socket must be located near the equipment and must be easily accessible.
- Keep this equipment away from humidity.
- Put this equipment on a stable surface during installation. Dropping it or letting it fall may cause damage.
- Do not leave this equipment in either an unconditioned environment or in a above 40°C storage temperature as this may damage the equipment.
- The openings on the enclosure are for air convection to protect the equipment from overheating. DO NOT COVER THE OPENINGS.
- Make sure the voltage of the power source is correct before connecting the equipment to the power outlet.
- Place the power cord in a way so that people will not step on it. Do not place anything on top of the power cord. Use a power cord that has been approved for use with the product and that it matches the voltage and current marked on the product's electrical range label. The voltage and current rating of the cord must be greater than the voltage and current rating marked on the product.
- All cautions and warnings on the equipment should be noted.

- If the equipment is not used for a long time, disconnect it from the power source to avoid damage by transient overvoltage.
- Never pour any liquid into an opening. This may cause fire or electrical shock.
- Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.
- If one of the following situations arises, get the equipment checked by service personnel:
 - a. The power cord or plug is damaged.
 - b. Liquid has penetrated into the equipment.
 - c. The equipment has been exposed to moisture.
 - d. The equipment does not work well, or you cannot get it to work according to the user's manual.
 - e. The equipment has been dropped and damaged.
 - f. The equipment has obvious signs of breakage.
- Do not place heavy objects on the equipment.
- The unit uses a three-wire ground cable which is equipped with a third pin to ground the unit and prevent electric shock. Do not defeat the purpose of this pin. If your outlet does not support this kind of plug, contact your electrician to replace your obsolete outlet.
- CAUTION: DANGER OF EXPLOSION IF BATTERY IS INCORRECTLY REPLACED. REPLACE ONLY WITH THE SAME OR EQUIVALENT TYPE RECOMMENDED BY THE MANUFACTURER. DISCARD USED BATTERIES ACCORDING TO THE MANUFACTURER'S INSTRUCTIONS.
- The computer is provided with CD drives that comply with the appropriate safety standards including IEC 60825.

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Technical Support and Assistance

- 1. For the most updated information of NEXCOM products, visit NEXCOM's website at www.nexcom.com.
- 2. For technical issues that require contacting our technical support team or sales representative, please have the following information ready before calling:
 - Product name and serial number
 - Detailed information of the peripheral devices
 - Detailed information of the installed software (operating system, version, application software, etc.)
 - A complete description of the problem
 - The exact wordings of the error messages

Warning!

- 1. Handling the unit: carry the unit with both hands and handle it with care.
- 2. Maintenance: to keep the unit clean, use only approved cleaning products or clean with a dry cloth.
- 3. CompactFlash: Turn off the unit's power before inserting or removing a CompactFlash storage card.

Conventions Used in this Manual



Warning:

Information about certain situations, which if not observed, can cause personal injury. This will prevent injury to yourself when performing a task.



Caution:

Information to avoid damaging components or losing data.

Note:

Provides additional information to complete a task easily.



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Package Contents

Before continuing, verify that the VTC 1010 series package that you received is complete. Your VTC 1010 series package should have all the items listed in the following table.

Item	P/N	Name	Specification	Qty
1	4NCPM00302X00	(T)Terminal Blocks 3P Phoenix Contact:1777992	5.08mm Male DIP Green	1
2	50311F0100X00	(H)Round Head Screw w/Spring+Flat Washer Long FEI:P3x6L	P3x6 iso/SW6x0.5 NI	4
3	50311F0110X00	(H)Flat Head Screw Long FEI:F3x5ISO+NYLOK NIGP	F3x5 NI NYLOK	4
4	5040420015X00	VTC 1010 HDD Bracket VER:A PANADVANCE	95.35x112x12 SPCC NI PAINTING	1
5	60233AT134X00	SATA Cable ST:MD-6102069	SATA7P/L 180D TO 90D L=75mm	1
6	60233PW197X00	SATA Power Cable Best:900-0415-070R	Female Connector 15P to Housing 4P PIT:2.54mm L:70mm	1
7	602DCD0769X00	(N)VTC 1010 CD Driver VER:1.0	JCL	1
8	6030000039X00	Composite Cable for VTC 1010 ST:13-210-E012	DMS 60PIN L=300mm	1
9	603VED0001X00	Capture Card Cable for MPX-885 ST:VT-1009F2 27-54	IDC10P PH:1.24x2.54 TI PH:1.27x1.27 L=90mm	1



Ordering Information

The following provides ordering information for VTC 1010.

• VTC 1010-BK (P/N: 10V00101000X0)

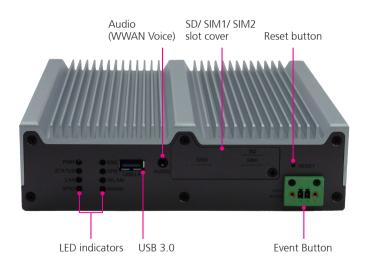
Intel[®] Atom[™] processor E3827 1.75GHz CPU, 2GB DDR3L SO-DIMM, VGA/DP Output, 1x LAN, 2x RS-232, 1x RS-422/485, 3x DI, 3x DO, 3x USB, 12VDC output



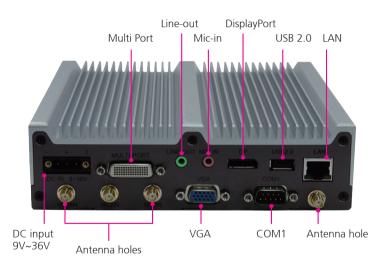
Chapter 1: Product Introduction

Physical Features

Front View



Rear View





Overview

VTC 1010 features next generation Intel[®] Atom[™] processor E3827, 1.75GHz, with powerful graphic and multimedia enhancement. VTC 1010 is packed rugged, fanless, and 1 DIN compact enclosure. It is specifically designed to comply with stringent MIL-STD-810G military standard. VTC 1010 comes with built-in CAN BUS 2.0B interface and optional OBDII (ASE J1939/ J1708) port to monitor the vehicle operating status real-time and troubleshoot a non-working vehicle. With dual SIM card design, it allows the choice of the best service carrier network and minimizes roaming cost. VTC 1010 can be configured to work with two independent WWAN connections and can effectively increase the bandwidth for faster massive data transfer over the air. VTC 1010 also supports two-way voice communication. Equipped with intelligent vehicle power management, VTC 1010 can be waked up by ignition, timer, or remote dial-up for flexible operation or maintenance. VTC 1010 can satisfy different demands for versatile telematics applications, such as infotainment, fleet management, dispatching system and mobile video surveillance

Key Features

- Intel[®] Atom[™] processor E3827, 1.75GHz
- Dual SIM cards + dual WWAN modules support
- Built-in U-blox M8N GPS, optional Dead Reckoning support
- Built-in CAN 2.0B. Optional CAN/OBDII Combo Module (SAE J1939/ CAN2.0B by DIP Switch)
- 4x Mini-PCIe expansions
- Wake on RTC/SMS via WWAN module
- Compliant with MIL-STD-810G
- Built-in G-sensor, Gyroscope, and e-Compass sensors



Hardware Specifications

CPU

- Intel[®] Atom[™] processor E3827, dual core 1.75GHz

Memory

 1x 204-pin DDR3L SO-DIMM socket support 1066MHz / 1333MHz up to 8GB. Default 2GB

Storage

- 1x 2.5" SATA 2.0
- 1x SD card socket

Expansion

- 1x full size Mini-PCIe socket (USB 2.0)
- 1x full size Mini-PCIe socket (USB 2.0 + PCIe)
- 1x full size Mini-PCIe socket (mSATA or PCIe)
- 1x half size Mini-PCle socket (USB 2.0 + PCle)

Function

- 1x default U-blox M8N GPS module (72-channel, GPS, GLONASS, BeiDou, SBAS) or optional modules with Dead Reckoning support
- Built-in G-sensor, Gyroscope, and e-Compass sensors

I/O Interface-Front

- 8x LED for power, system status, storage, WWAN, WLAN, GPS, LAN, GPIO
- 2x external accessible SIM card socket (selectable) with cover
- 1x audio jack 3.5mm for WWAN voice communication, including 1x Mic-in and 1x Line-out
- 1x external accessible SD card socket with cover
- 1x event button (trigger type)
- 1x reset button

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• 1x type A USB 3.0 compliant host, supporting system boot up.

I/O Interface-Rear

- 1x 9~36VDC input with ignition and 11W typical power consumption
- 1x type A USB 2.0 compliant host, supporting system boot up
- 1x RJ45 10/100/1000 Fast Ethernet with LED
- 1x phone jack 3.5mm for Mic-in (for WWAN voice communication)
- 1x phone jack 3.5mm for Line-out (for PC audio)
- 1x DB-15 VGA. Resolution up to 2500 x 1600 @60Hz
- 1x DP port. Resolution up to 2500 x 1600 @60Hz
- 1x DB-9 for RS-232
- 4x antenna hole for GPS/ WWAN/ WLAN/ BT
- 1x LHF 60-pin connector
 - 1x 6-pin power connector, 12VDC output (max: 1A) 1x type A female USB 2.0 compliant host, supporting system boot up. 1x DB-9 RS-232 1x DB-9 RS-422/ 485 1x DB-9 female 3x DI and 3x DO. Onboard CAN 2.0B signals (Programmable Digital Input) Input Voltage (Internal Type): 5VDC TTL (default) Input Voltage (Source Type): 3~12VDC (Programmable Digital Output) Digital Output (Sink Type): 5VDC TTL (default), max current: 20mA Digital Output (Source Type): 3~24VDC, max current: 150mA 1x DB-9 for optional ODBII module (ASE J1939 or J1708) 1x DB-9 for optional GPS Dead Reckoning module 4x BNC connector video-in for optional 4-channel video capture card 4x audio connector for 7.1 channel audio output (front, center/ woofer, rear surround, side surround)

Power Management

• Selectable boot-up & shut-down voltage for low power protection by software



- Setting 8-level power on/off delay time by software
- Status of ignition and low voltage can be detected by software
- Support S3/ S4 suspend mode

Operating System

- Windows 8 Professional, WES8
- Windows 7, WES7
- Tizen IVI
- Fedora

Dimensions

- 180 mm (W) x 180 mm (D) x 50 mm (H) (7.09" x 7.09" x 1.97")
- 1.7kg

Construction

- Fanless
- Aluminum fin top cover and front/ rear panels
- SECC bottom enclosure

Environment

- Operating temperatures: -30°C to 70°C (w/ industrial SSD) with air flow -10°C to 50°C (w/ commercial HDD) with air flow
- Storage temperatures: -35°C to 85°C
- Relative humidity: 10% to 90% (non-condensing)
- Vibration (random): 1g@5~500 Hz (in operation, SSD)
- Vibration (SSD):

Operating: MIL-STD-810G, Method 514.6, Category 4, common carrier US highway truck vibration exposure

- Storage: MIL-STD-810G, Method 514.6, Category 24, minimum integrity test
- Shock (SSD):

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Operating: MIL-STD-810G, Method 516.6, Procedure I, functional shock=20g Non-Operating: MIL-STD-810G, Method 516.6, Procedure V, crash hazard shock test=75g

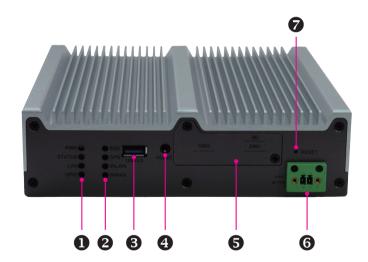
Certifications

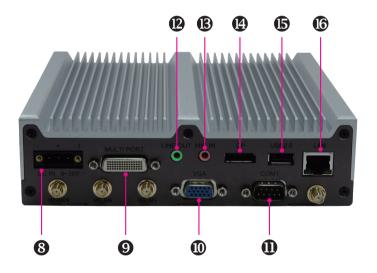
- CE approval
- FCC Class B
- E13 Mark



Connector Numbering

The following diagrams indicate the numbers of the connectors. Use these numbers to locate the connectors' respective pinout assignments on chapter 2 of the manual.



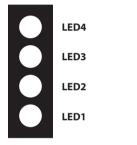




Chapter 2: External Connectors Pinout Description

LED Indicators (PWR, Status, LAN & GPIO)

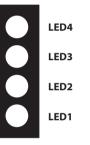
Connector Number: 1



LED	LED Behavior		
LED1 (GPIO)	Off (Default)		
	Green: On. Programmable by user.		
LED2 (LAN)	Green: Link		
LEDZ (LAN)	Blinking: Active		
LED3 (HEALTH)	Steady Green: System ready		
	Steady Red: System booting		
LED4 (POWER)	Blue: Power good		
	Red: Power failure		

LED Indicators (SSD, GPS, WLAN & WWAN)

Connector Number: 2



LED	LED Behavior
LED1 (WWAN)	Green: WWAN On
LED2 (WLAN)	Green: WLAN Connected. Off: Disconnected
LED3 (GPS)	Green: GPS power On
LED4 (SSD)	Green: Storage access



USB 3.0 Port

Connector Number: 3

1 9 5 4

Audio Jack 3.5mm

Connector Number: 4



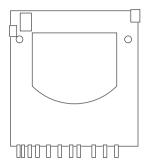
Pin	Definition	Pin	Definition
1	5V	2	USB_N
3	USB_P	4	GND
5	USB3_RXN	6	USB3_RXP
7	GND	8	USB3_TXN
9	USB3_TXP		

Pin	Definition	Pin	Definition
1	MIC-C1	2	GND
3	FRONT_RC1	4	FRONT_LC1
5	CON DET	G1	GND
G2	GND		



SD Card Connector

Connector Number: 5



SIM1 Socket

Connector Number: 5



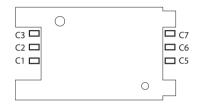
Pin	Definition	Pin	Definition
1	D3	2	CMD
3	GND	4	VDD
5	CLK	6	GND
7	D0	8	D1
9	D2	WP	WP
Cd	CDZ	SC	GND
G	GND		

Pin	Definition	Pin	Definition
C1	UIM1_PWR2	C5	GND
C2	UIM1_RST2	C6	NC
C3	UIM1_CLK2	С7	UIM1_DAT2



SIM2 Socket

Connector Number: 5



Connector Number: 6



Pin	Definition	Pin	Definition
C1	UIM2_PWR2	C5	GND
C2	UIM2_RST2	C6	NC
C3	UIM2_CLK2	С7	UIM2_DAT2

Pin	Definition
1	Front Event
2	GND



Reset Button

-

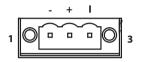
Connector Number: 7



Pin	Definition
1-2 Open	NORMAL
1-2 Short	RESET#

Power Input

Connector Number: 8

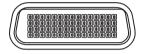


Pin	Definition		
1	GND_IN		
2	V_IN		
3	IGNITION		



Multiport Connector

Connector Number: 9





When connecting the multiport cable, please make sure the top side labeled "TOP" is facing upwards.



Pin	Definition	Pin	Definition
1	OUT_12V	16	CEN_JD
2	SP_DTR_3	17	CEN_C
3	SP_TXD_3	18	LFE_C
4	GPIO1	19	AGND
5	GPIO2	20	RS485
6	USB1_POWER	21	RS485_+
7	USB_2N_L	22	ISO_GND
8	USB_2P_L	23	ISO_GND
9	USB_GND	24	ISO_GND
10	RS422_TX-	25	ISO_GND
11	RS422_TX+	26	GPIO3
12	AGND	27	GPIO4
13	FRONT_L_C	28	SP_RXD_3
14	FRONT_R_C	29	SP_DCD_3
15	FRONT_JD	30	OUT_12V

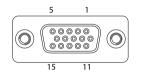
Pin	Definition	Pin	Definition
31	GND	46	SIDE_JD
32	SP_CTS_3	47	SIDE_R_C
33	SP_DSR_3	48	SIDE_L_C
34	GPIO5	49	AGND
35	GPIO6	50	C1708_1_L
36	CAP2_A	51	C1708_1_H
37	CAN1_H	52	DIRECTION
38	CAN1_L	53	ODOMETER
39	CAN_M_L	54	1PPS
40	CAN_M_H	55	CAP2_B
41	REAR_PANIC	56	CAP1_A
42	AGND	57	CAP1_B
43	SURR_OUT_L_C	58	SP_RTS_3
44	SURR_OUT_R_C	59	SP_RI_3
45	SURR_JD	60	GND



VGA Connector

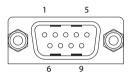
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Connector size: DB15, Female Connector Number: 10



RS232 Connector

Connector size: DB9, Male Connector Number: 11



Pin	Definition	Pin	Definition
1	Red	2	Green
3	Blue	4	NC
5	Gnd	6	Red_RTN
7	Green_RTN	8	Blue_RTN
9	+5V	10	GND
11	NC	12	I2C_Data
13	H SYNC	14	V SYNC
15	I2C_CLK		

Pin	Definition	Pin	Definition
1	DCD	2	RXD
3	TXD	4	DTR
5	GND	6	DSR
7	RTS	8	CTS
9	RI		



Line-out

Connector Number: 12

Mic-in

Connector Number: 13





Pin	Definition	Pin	Definition
1	Line2 LC	2	Line2 JD
3	NC	4	Line2 RC
5	GND	6	GND

Pin	Definition	Pin	Definition
1	Mic1 C	2	Mic2 JD
3	NC	4	Mic1 CL
5	GND	6	GND



DisplayPort

-

Connector Number: 14

USB 2.0 Port

Connector Number: 15



Pin	Definition	Pin	Definition
1	DP0_DATA0_P	2	GND
3	DP0_DATA0_N	4	DP0_DATA1_P
5	GND	6	DP0_DATA1_N
7	DP0_DATA2_P	8	GND
9	DP0_DATA2_N	10	DP0_DATA3_P
11	GND	12	DP0_DATA3_N
13	CONFIG1	14	CONFIG2
15	DPC0_AUXP_C	16	GND
17	DPC0_AUXN_C	18	HPD
19	RETURN	20	DP0_PWR

Pin	Definition	Pin	Definition
1	5V	2	USB_N
3	USB_P	4	GND



LAN Connector

Connector Number: 16



Pin	Definition	Pin	Definition
1	MDIOP	2	MDION
3	MDI1P	4	MDI2P
5	MDI2N	6	MDI1N
7	MDI3P	8	MDI3N
9	LED1-	10	LED1+
11	LED2-	12	LED2+



Chapter 3: Jumpers and Switches

This chapter describes how to set the jumpers on the motherboard. Note that the following procedures are generic for all VTC 1010 series.

Before You Begin

- Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.
- Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:
 - A Philips screwdriver
 - A flat-tipped screwdriver
 - A set of jewelers screwdrivers
 - A grounding strap
 - An anti-static pad

NEXCOM

- Using your fingers can disconnect most of the connections. It is recommended that you do not use needle-nosed pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.
- Before working on internal components, make sure that the power is off. Ground yourself before touching any internal components, by touching a metal object. Static electricity can damage many of the electronic components. Humid environment tend to have less static electricity than

dry environments. A grounding strap is warranted whenever danger of static electricity exists.

Precautions

Computer components and electronic circuit boards can be damaged by discharges of static electricity. Working on the computers that are still connected to a power supply can be extremely dangerous.

Follow the guidelines below to avoid damage to your computer or yourself:

- Always disconnect the unit from the power outlet whenever you are working inside the case.
- If possible, wear a grounded wrist strap when you are working inside the computer case. Alternatively, discharge any static electricity by touching the bare metal chassis of the unit case, or the bare metal body of any other grounded appliance.
- Hold electronic circuit boards by the edges only. Do not touch the components on the board unless it is necessary to do so. Don't flex or stress the circuit board.
- Leave all components inside the static-proof packaging that they shipped with until they are ready for installation.
- Use correct screws and do not over tighten screws.

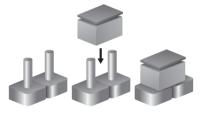


Jumper Settings

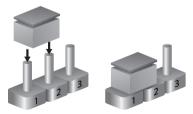
A jumper is the simplest kind of electric switch. It consists of two metal pins and a cap. When setting the jumpers, ensure that the jumper caps are placed on the correct pins. When the jumper cap is placed on both pins, the jumper is short. If you remove the jumper cap, or place the jumper cap on just one pin, the jumper is open.

Refer to the illustrations below for examples of what the 2-pin and 3-pin jumpers look like when they are short (on) and open (off).

Two-Pin Jumpers: Open (Left) and Short (Right)



Three-Pin Jumpers: Pins 1 and 2 are Short

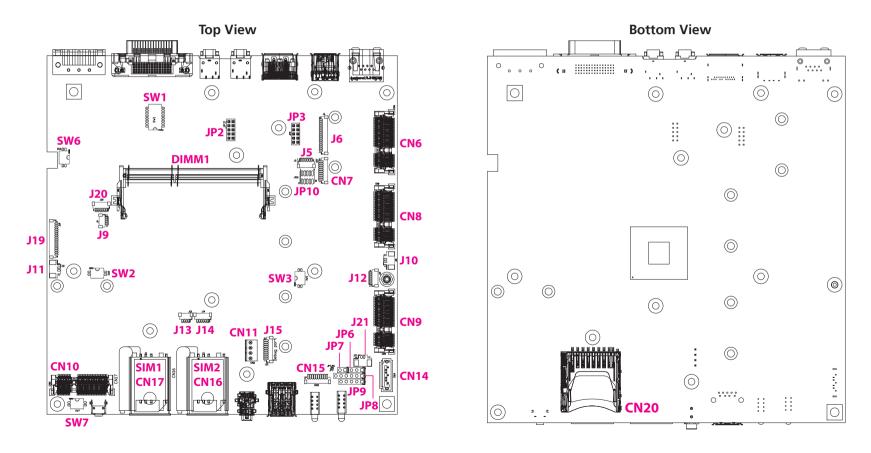




VTC 1010 Connector Specification & Jumper Setting

VTC 1010 carrier board placement

The figure below is the carrier board used in the VTC 1010 system. It shows the locations of the jumpers and connectors.





VTC 1010 Jumper and Switch Settings

CMOS Clear Switch

Connector location: SW2

Voltage Selector (F	or CN10 Connector)
---------------------	--------------------

Connector location: SW6



	On	Off
SW2.1	Clear CMOS	Normal
SW2.2	Clear ME	Normal

3.3V 3.6V SW6.1 Off On SW6.2 Off On

Default Settings:

SW2.1	Off
SW2.2	Off

Note: Once CMOS is cleared and the power connector is plugged in, VTC 1010 will power on and power off automatically in the first Power-On. After first Power-On, VTC 1010 will work normally.

Default Settings:

SW6.1	Off
SW6.2	Off

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WWAN Module Selector (For Wake-Up & Voice on CN10)

Connector location: SW7

RTC Battery Connector

Connector size: $1 \times 2 = 2$ -pin header (1.25mm) Connector location: J11



	WWAN HE910 Wake-Up & Voice	WWAN CM8000 Wake-Up & Voice	WWAN MC8090/8092
SW7.1	On	Off	Off
SW7.2	Off	On	On
Digital Voice*	HE910 (I2S)	Disabled (default)	MC8090(PCM)

Pin	Definition	
1	GND	
2	RTC_BAT	

Default Settings:

SW7.1	Off
SW7.2	On

*Digital voice is selectable in BIOS.

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External Thermal Sensor Module

Connector size: 1 x 2 = 2-pin header Connector location: JP7

Debug 80 Port Connector

Connector size: 1 x 10 = 10-pin header (1.0mm) Connector location: J15



Pin	Definition	Pin	Definition
1	GND	2	PCIRST#
3	33M_CLK	4	LPC_FRAME#
5	LPC_AD3	6	LPC_AD2
7	LPC_AD1	8	LPC_AD0
9	VCC3	10	VCC3

Pin	Definition	
1	Sensor	
2	Sensor	



VGA Connector

16

Connector size: $1 \times 16 = 16$ -pin header (1.0mm) Connector location: J6

COM Port Connector

Connector size: 1 x 10 = 10-pin header (1.0mm) Connector location: CN7



Pin	Definition	Pin	Definition
1	GND	2	VGA +5V
3	VGA_CLK	4	VGA_DATA
5	VGA_VS	6	VGA_HS
7	GND	8	GND
9	GND	10	VGA_GND
11	VGA_BLUE	12	VGA_GND
13	VGA_GREEN	14	VGA_GND
15	VGA_RED	16	M_DET

Pin	Definition	Pin	Definition
1	GND	2	GND
3	CTS	4	DSR
5	DTR	6	RXD
7	RI	8	RTS
9	TXD	10	DCD

10



High Speed UART Connector

Connector size: 1 x 10 = 10-pin header (1.0mm) Connector location: CN15

OBDII Module Connector

Connector size: $2 \times 5 = 10$ -pin header (2.0mm) Connector location: JP2 & JP3

2	\bigcirc	0	0	0	0	10
1		0	0	0	\bigcirc	9

Pin	Definition	Pin	Definition
1	GND	2	SIO_RTS_1
3	SIO_TXD_1	4	SIO_CTS_1
5	SIO_RXD_1	6	GND
7	SIO_CTS_0	8	SIO_RXD_0
9	SIO_RTS_0	10	SIO_TXD_0

JP2

Pin	Definition	Pin	Definition
1	CAN2.0B_H	2	CAN_1939_H
3	CAN2.0B_L	4	CAN_1939_L
5	GND	6	GND
7	ANALOG-Input1	8	ANALOG-Input2
9	ANALOG-Input3	10	ANALOG-GND

JP3

Pin	Definition	Pin	Definition
1	TXD	2	RXD
3	CAN_DI1	4	CAN_DO1
5	GND	6	GND
7	NC	8	NC
9	CAN_M_VCC5	10	NC



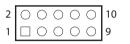
Capture Card Connector

(Connector for SC330 video capture card) Connector size: 1 x 6 = 6-pin header (1.0mm) Connector location: J5



Capture Card Connector

(Connector for MPX-885 video capture card) Connector size: $2 \times 5 = 10$ -pin header (1.27mm) Connector location: JP10



Pin	Definition	Pin	Definition
1	GND	2	CAP2_B
3	CAP2_A	4	CAP1_B
5	CAP1_A	6	GND

Pin	Definition	Pin	Definition
1	CAP1_A	2	CAP1_B
3	CAP2_A	4	CAP2_B
5	GND	6	NC
7	NC	8	NC
9	NC	10	NC



5V Output

Connector size: 1 x 2 = 2-pin header (1.25mm) Connector location: J21

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1		\bigcirc	2

Pin	Definition
1	+
2	_

Event Button Connector

Connector size: $1 \times 2 = 2$ -pin header (1.25mm) Connector location: J10



J10

Pin	Definition
1	GND
2	FRONT_EVENT



SATA HDD Connector

Connector size: CN11, 1 x 4 = 4-pin header (2.54mm) CN14, 1 x 7 = 7-pin header (1.27mm) Connector location: CN11 & CN14



1 0 0 3

MCU Debug Port

Connector location: JP6



CN11

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Pin	Definition	Pin	Definition
1	VCC12	2	GND
3	GND	4	VCC5

Pin	Definition
1	TX6
2	RX6
3	GND

Connector size: $1 \times 3 = 3$ -pin header (2.54mm)



CN14

Pin	Definition	Pin	Definition
1	GND	2	SATA_TXP0
3	SATA_TXN0	4	GND
5	SATA_RXN0	6	SATA_RXP0
7	GND		



GAL Download Port

Connector size: $1 \times 6 = 6$ -pin header (2.54mm) Connector location: JP8

MCU Download Port

Connector size: $1 \times 5 = 5$ -pin header (2.54mm) Connector location: JP9

1 0 0 0 0 0 6

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Pin	Definition	Pin	Definition
1	VCC3	2	GND
3	TCK	4	TDO
5	TDI	6	TMS

Pin	Definition	Pin	Definition
1	V3.3ALW	2	C2D
3	MRST	4	C2CK
5	GND		



GPIO Setting

Connector location: SW1

oz	
0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	

SW On Off SW1.1 Pull up VCC5 Don't care SW1.2 Pull up VCC5 Don't care SW1.3 Pull up VCC5 Don't care SW1.4 Pull up VCC5 Don't care SW1.5 Pull up VCC5 Don't care SW1.6 Pull up VCC5 Don't care SW1.7 NC NC SW1.8 NC NC

Default Settings:

SW1.1	On
SW1.2	On
SW1.3	On
SW1.4	On
SW1.5	On
SW1.6	On
SW1.7	On
SW1.8	On

Voltage Setup Selection

Connector location: SW3



PowerSW (SW3.1)	Off	Off	On
12V 24V (SW3.2)	Off	On	Don't Care
	12V	24V	9~36V

Default Settings:

Power Range (9~36V)			
SW3.1 On			
SW3.2 Don't Care			



FAN Connector

Connector size: $1 \times 4 = 4$ -pin header Connector location: J9

VIOB-GPS-DR01

Connector size: $1 \times 4 = 4$ -pin header Connector location: J13





Pin	Definition	Pin	Definition
1	GND	2	Power
3	FAN_TACT	4	FAN_CTRL

Pin	Definition	Pin	Definition
1	GND	2	IPPS
3	ODOMETER	4	DIRECTION

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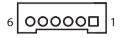


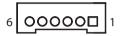
GPS Module Connector

Connector size: $1 \times 6 = 6$ -pin header Connector location: J14

MCU GPIO Connector

Connector size: 1 x 6 = 6-pin header Connector location: J12





Pin	Definition	Pin	Definition
1	GPS_BAT	2	GPS_LED
3	GPS_CTX	4	GPS_CRX
5	GND	6	VCC3_GPS

Pin	Definition	Pin	Definition
1	GND	2	MCU GPO2
3	MCU GPO1	4	MCU GPI2
5	MCU GPI1	6	GND



PCle Connector

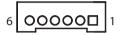
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Connector size: $1 \times 16 = 16$ -pin header Connector location: J19

Expand Connector

Connector size: $1 \times 6 = 6$ -pin header Connector location: J20





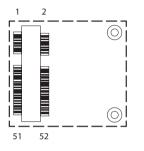
Pin	Definition	Pin	Definition
1	GND	2	PCIE_CLKN
3	PCIE_CLKP	4	GND
5	PCIE_RXN	6	PCIE_RXP
7	GND	8	PCIE_TXN
9	PCIE_TXP	10	GND
11	USBHUB_3N	12	USBHUB_3P
13	GND	14	PLTRST
15	EXP_Disable	16	GND

Pin	Definition	Pin	Definition
1	GND	2	GND
3	GND	4	12VSB
5	12VSB	6	12VSB

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Mini-PCle (USB + PCle)

Connector location: CN6



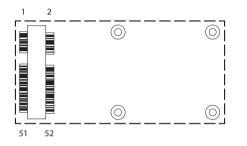
Pin	Definition	Pin	Definition
1	WAKE#	2	+V3.3A_MINI1
3	NC	4	GND
5	NC	6	+V1.55_MINI1
7	CLK_REQ#	8	NC
9	GND	10	NC
11	PCIE_CLK#	12	NC
13	PCIE_CLK	14	NC
15	GND	16	NC
17	NC	18	GND
19	NC	20	WLAN_DIS#
21	GND	22	RESET#
23	PCIE_RX_N	24	+V3.3A_MINI1
25	PCIE_RX_P	26	GND

Pin	Definition	Pin	Definition
27	GND	28	+V1.55_MINI1
29	GND	30	SMBCLK
31	PCIE_TX_N	32	SMBDAT
33	PCIE_TX_P	34	GND
35	GND	36	USB-
37	GND	38	USB+
39	+V3.3A_MINI1	40	GND
41	+V3.3A_MINI1	42	NC
43	GND	44	WLAN_LED#
45	NC	46	NC
47	NC	48	+V1.55_MINI1
49	NC	50	GND
51	BT_EN	52	+V3.3A_MINI1



Mini-PCle (mSATA or PCle [default])

Connector location: CN9



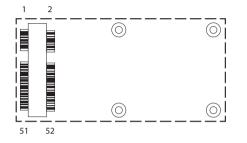
Pin	Definition	Pin	Definition
1	WAKE#	2	+V3.3_MINI_3
3	NC	4	GND
5	NC	6	+V1.5S_MINI_3
7	CLKREQ	8	NC
9	GND	10	NC
11	REFCLK-	12	NC
13	REFCLK+	14	NC
15	GND	16	NC
17	NC	18	GND
19	NC	20	MINICARD3_DIS#
21	GND	22	WLAN_RESET#
23	SATA_RXP0_C	24	+V3.3_MINI_3
25	SATA_RXN0_C	26	GND

Pin	Definition	Pin	Definition
27	GND	28	+V1.5S_MINI_3
29	GND	30	SMBCLK
31	SATA_TXN0_C	32	SMBDAT
33	SATA_TXP0_C	34	GND
35	GND	36	USB_D-
37	GND	38	USB_D+
39	+V3.3_MINI_3	40	GND
41	+V3.3_MINI_3	42	WWAN_LED#
43	GND	44	NC
45	NC	46	NC
47	NC	48	+V1.5S_MINI_3
49	NC	50	GND
51	CTRLO	52	+V3.3_MINI_3



Mini-PCle (USB + PCle)

Connector location: CN8 SIM Socket: SIM 2 (CN16)



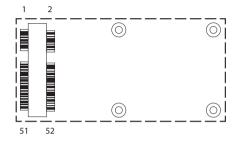
Pin	Definition	Pin Definition	
1	PCIE_WAKE#2	2	+V3.3A_MINI_2
3	NC	4	GND
5	NC	6	+V1.55_MINI_2
7	CLK_REQ#2	8	UIM2_PWR2_MINI
9	GND	10	UIM2_DAT2_MINI
11	PCIE_CLK#2	12	UIM2_CLK2_MINI
13	PCIE_CLK2	14	UIM2_RST2_MINI
15	GND	16	NC
17	NC	18	GND
19	NC	20	PCIE2_DIS#
21	GND	22	PCIE2_RST#
23	PCIE_RX_N2	24	+V3.3A_MINI_2
25	PCIE_RX_P2	26	GND

Pin	Definition	Pin	Definition
27	GND	28	+V1.55_MINI_2
29	GND	30	SMBCLK
31	PCIE_TX_N2	32	SMBDAT
33	PCIE_TX_P2	34	GND
35	GND	36	USB-
37	GND	38	USB+
39	+V3.3A_MINI_2	40	GND
41	+V3.3A_MINI_2	42	NC
43	GND	44	PCIE2_LED
45	NC	46	NC
47	NC	48	+V1.55_MINI_2
49	NC	50	GND
51	NC	52	+V3.3A_MINI_2



Mini-PCle (USB)

Connector location: CN10 SIM Socket: SIM1 (CN17)

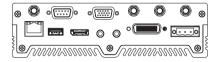


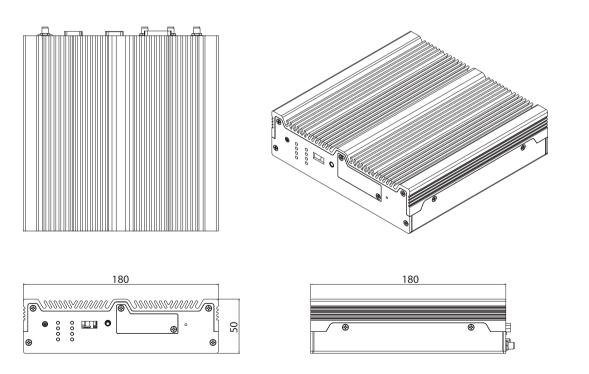
Pin	Definition	Pin	Definition
1	MINI_MIC_P	2	+V3.3A_MINI_4
3	MINI_MIC_N	4	GND
5	MINI_SPK_PRR	6	NC
7	U_GND	8	UIM_PWR2
9	GND	10	UIM_DAT2
11	VCC_MSM26_DIG	12	UIM_CLK2
13	NC	14	UIM_RST2
15	GND	16	NC
17	NC	18	GND
19	NC	20	3.5G_DIS#
21	GND	22	3.5G_RST#
23	NC	24	+V3.3A_MINI_4
25	NC	26	GND

Pin	Definition	Pin	Definition
27	GND	28	NC
29	GND	30	NC
31	NC	32	SMS_RI_3.5G_R
33	UMTS_RESET#_R	34	GND
35	GND	36	USB-
37	GND	38	USB+
39	+V3.3A_MINI_4	40	GND
41	+V3.3A_MINI_4	42	3.5G_LED#_R
43	GND	44	NC
45	PCM_CLK	46	NC
47	PCM_RX	48	NC
49	PCM_TX	50	GND
51	PCM_SYNC	52	+V3.3A_MINI_4



Chapter 4: Mechanical Dimensions









Chapter 5: System Setup

Removing the Chassis Cover



Prior to removing the chassis cover, make sure the unit's power is off and disconnected from the power sources to prevent electric shock or system damage.



Front View



Rear View



Installing the First WWAN Module

1. The Mini PCI Express slot (CN10) shown below is used to install a WWAN communication module such as GPRS, UMTS or HSDPA module. This WWAN module is paired with SIM socket 1.



2. Insert the module into the Mini PCI Express slot at a 45 degrees angle until the gold-plated connector on the edge of the module completely disappears inside the slot. Then fasten screws into the mounting holes to secure the module.





3. Attach one end of the RF cable onto the module.



4. Mount the other end of the cable to the antenna mounting hole (WWAN) located at the front panel of the chassis.

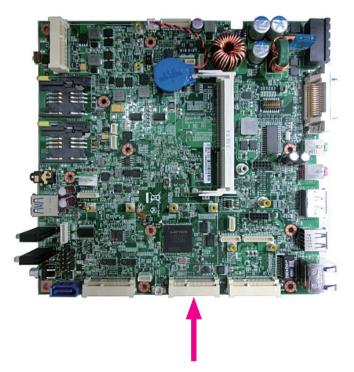


WWAN antenna hole



Installing the Second WWAN Module

1. The Mini PCI Express slot (CN8) shown below is used to install a WWAN communication module such as GPRS, UMTS or HSDPA module. This WWAN module is paired with SIM socket 2.



2. Insert the module into the Mini PCI Express slot at a 45 degrees angle until the gold-plated connector on the edge of the module completely disappears inside the slot. Then fasten screws into the mounting holes to secure the module.





3. Attach one end of the RF cable onto the module.



4. Mount the other end of the cable to the antenna mounting hole (WWAN) located at the front panel of the chassis.



WWAN antenna hole



Installing a Wireless LAN Module

1. The Mini PCI Express slot (CN6) shown below is used to install a wireless LAN module.



2. Insert the module into the Mini PCI Express slot at a 45 degrees angle until the gold-plated connector on the edge of the module completely disappears inside the slot. Then fasten screws into the mounting holes to secure the module, and attach one end of the RF cable onto the module.





3. Mount the other end of the cable to the antenna mounting hole (WLAN) located at the front panel of the chassis.



WLAN antenna hole

.

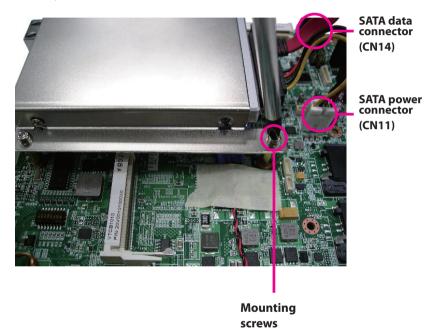


Installing a SATA SSD Drive

1. Place the SDD drive into the HDD mounting bracket and then tighten the four screws.



2. Fasten the HDD bracket within the chassis and connect the SATA data and power cable onto connectors CN14 and CN11.

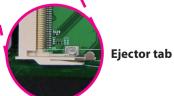




Installing a SO-DIMM

1. Push the ejector tabs which are at the ends of the socket outward. Then insert the module into the socket at an approximately 30 degrees angle. Apply firm even pressure to each end of the module until it slips down into the socket. The contact fingers on the edge of the module will almost completely disappear inside the socket.

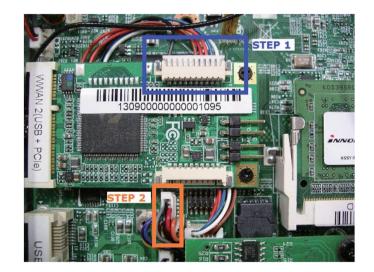




Installing a Capture Card

Model: Yuan SC330 N4

- 1. Connect capture card cable onto the capture card.
- 2. Connect capture card cable to the J5 connector on VTC 1010.





Appendix A: Software Demo Utility for I/O Ports of Function Control

NEXCOM's software demo utility enables users to test and control different I/O port functions on the VTC 1010. This document shows how to use the utility.

There are also source code files of the utility in the CD. Users can refer to the source codes to develop their applications.

Menu Screen

🔏 VTC1010_IO_Ut	ility		×
Status Ignition Status	GPIO Setting GPO 1 Low V GPO V	MCU GPIO Setting MCU GPO 1 Low V MCU GPO 1 Low V Isable V Isable V Isable V Isable V Isable V	Mini-PCIe Module Power CN6 ON/OFF ON V Don't care
Battery Status	GPO 1 Set GPI 1 Read GPI 0 1 GPO 2 Low V GPO V	MCU GPO 1 Set	Set Set
	GPO 2 Set GPI 2 Read GPI 0 2 Select	MCU GPO 2 Set Clear Timer Power Off Delay Time Disable	ON OBDII Module Power Reset Set Don't care CN9 ON/OFF
Unknown	GPO 3 Low GPO 3 Set GPI 3 Read GPI 0 3 Select	MCU GPI 1 Read Enable SIM Card 1 V	ON
Set	GPO 4 Low GPI GPI GPI GPI GPI GPI GPI GPI	MCU GPI 2 Read Set Wake Up Function 3G	GPS Module POWER ON/OFF ON Get Get
Output Power External +12V Enable	GPO 5 Low GPI 5 Read GPI 5 Read GPI 5 Read	Even Button Read Even Clear	Set
Enable 💌	GPD 6 Low V GPI V	GPIO LED Set Disable	
	GPO 6 Set GPI 6 Read GPI 0 6 Select	GPIO LED Set	

1.1 Status

1.1.1 Ignition Status

Press the button of Ignition Status, the signal of ignition will be shown. ON Signal of ignition is high. OFF Signal of ignition is low.

1.1.2 Battery Status

Press the button of Battery Status, the status of battery voltage will be shown. Low voltage Car battery is at low voltage. OFF Car battery is not at low voltage.

> Status Ignition Status Battery Status

1.1.3 Input Voltage

Shows the setting of input voltage on SW3.

1.1.4 Output Power

External +12V Enables or disables the output of 12VDC.

Input Voltage
Unknown
_
Set
Output Power
External +12V
Enable 💌
Set





1.2 GPIO Setting 1.2.1 GPIO Select

Defines GPIO port as GPO or GPI.

1.2.2 GPO Set

Selects the GPO ports and makes the output low or high.

1.2.3 GPI Read

Reads the status of GPI.

GPIO Setting		
GPO 1 Low 💌		GPO 💌
GPO 1 Set	GPI 1 Read	GPIO 1 Select
GPO 2 Low 💌		GPO 🔻
GPO 2 Set	GPI 2 Read	GPIO 2 Select
GPO 3 Low 💌		GPO 💌
GPO 3 Set	GPI 3 Read	GPIO 3 Select
GPO 4 Low 💌		GPI 💌
GPO 4 Set	GPI 4 Read	GPIO 4 Select
GPO 5 Low 👻		GPI 💌
GPO 5 Set	GPI 5 Read	GPIO 5 Select
GPO 6 Low 💌		GPI 💌
GPO 6 Set	GPI 6 Read	GPIO 6 Select

1.3 MCU GPIO Setting 1.3.1 MCU GPO Set

Selects MCU GPO ports and makes the output low or high.

1.3.2 MCU GPI Status

Shows the status of the MCU GPI.

MCU GPIO Setting
MCU GPO 1 Low 💌
MCU GPO 1 Set
MCU GPO 2 Low 💌
MCU GPO 2 Set
MCU GPI 1 Read
MCU GPI 2 Read

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1.3.3 Even Button Read

Shows the status of the Event Button.

1.3.4 GPIO LED

Sets the On/Off of the GPIO LED on front panel.

Even Button Read
Even Clear
GPIO LED
LED OFF -
GPIO LED Set

1.4 WDT Setting

Enables or disables the WDT function. There are 9 selections of time. The timer of WDT can also be cleared by button.

WDT Setti	ng —
Disable	-
1 sec	•
Set	
Clear Ti	mer

1.5 3G Module

Enables or disables the WWAN function. SIM card 1 or SIM card 2 can also be selected for the WWAN module.

- 3G Module
Enable 💌
SIM Card 1 💌
Set



1.6 RS-422/RS-485

Selects RS-422 or RS-485

-RS422/	RS4	85
RS-48	5	•
S	et	

1.7 Power On Delay Time

Enables or disables the power on delay time function. There are 8 selections of delay time.

Power On De	lay Time
Disable	-
10 sec	-
Set	

1.8 Power Off Delay Time

Enables or disables the power off delay time function. There are 8 selections of delay time.

Power Off Del	ay Time -
Disable	-
20 sec	•
Set	



1.9 Wake Up Function

1.9.1 3G

Enables or disables the wake up function for the WWAN module on mini-PCIe socket (CN10).

1.9.2 RTC

Enables or disables the RTC wake up function. The timer setting of RTC is located in BIOS setting.



2.0 Mini-PCle Module Power On/Off 2.0.1 CN6 On/Off Power on or off CN6.

2.0.2 CN8 On/Off Power on or off CN8.

2.0.3 CN9 On/Off Power on or off CN9.

2.0.4 GPS Module Power On/Off

Power on or off the GPS module.





2.1 CAN Bus Setting

2.1.1 OBDII Module Reset

Reset OBDII module.

2.1.2 OBDII Module Power Reset

Reset the power of OBDII module.

2.1.3 On Board CAN2.0B Data Link Status

Reads the connection status of CAN2.0B

CAN Bus Setting
OBDII Module Reset
Don't care 👻
Set
OBDII Module Power Reset
Don't care 🗨
Set
On Board CAN 2.0B Data Link Status
No data transfer
Get



Appendix B: GPS Feature

uBlox-NEO M8 Overview

The NEO-M8 series of standalone concurrent GNSS modules is built on the exceptional performance of the u-blox M8 GNSS (GPS, GLONASS, Galileo, BeiDou, QZSS and SBAS) engine in the industry proven NEO form factor.

The NEO-M8 series provides high sensitivity and minimal acquisition times while maintaining low system power. The NEO-M8M is optimized for cost sensitive applications, while NEO-M8N and NEO-M8Q provide best performance and easier RF integration. The NEO form factor allows easy migration from previous NEO generations. Sophisticated RF-architecture and interference suppression ensure maximum performance even in GNSS-hostile environments.

The NEO-M8 combines a high level of robustness and integration capability with flexible connectivity options. The future-proof NEO-M8N includes an internal Flash that allows simple firmware upgrades for supporting additional GNSS systems. This makes NEO-M8 perfectly suited to industrial and automotive applications.

The DDC (I2C compliant) interface provides connectivity and enables synergies with most u-blox cellular modules. For RF optimization the NEO-M8N/Q features an additional front-end LNA for easier antenna integration and a front-end SAW filter for increased jamming immunity.

u-blox M8 modules use GNSS chips qualified according to AEC-Q100, are manufactured in ISO/TS 16949 certified sites, and fully tested on a system level. Qualification tests are performed as stipulated in the ISO16750 standard: "Road vehicles – Environmental conditions and testing for electrical and electronic equipment".

Technical Specifications

Features

Receiver type	72-channel u-blox M GPS/QZSS L1 C/A, GI SBAS L1 C/A: WAAS, Galileo-ready E1B/C (LONĂSS L10F, Bei EGNOS, MSAS	Dou B1
Nav. update rate ¹	Single GNSS: up to 1	8 Hz	
	Concurrent GNSS: up	o to 10 Hz	
Position accuracy	2.0 m CEP		
		NEO-M8N/Q	NEO-M8M
Acquisition	Cold starts: Aided starts: Reacquisition:	26 s 2 s 1 s	27 s 4 s 1 s
Sensitivity	Tracking & Nav: Cold starts: Hot starts:	–167 dBm –148 dBm –156 dBm	–164 dBm –147 dBm –156 dBm
Assistance	AssistNow GNSS Onl AssistNow GNSS Offl AssistNow Autonome OMA SUPL & 3GPP c	ine (up to 35 day ous (up to 6 days	
Oscillator	TCXO (NEO-M8N/Q), Crystal (NEO-M8M)		
RTC crystal	Built-in		
Noise figure	On-chip LNA (NEO-N lowest noise figure (N		or

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Features cont.

Anti jamming	Active CW detection and removal. Extra onboard SAW band pass filter (NEO-M8N/Q)
Memory	ROM (NEO-M8M/Q) or Flash (NEO-M8N)
Supported antennas	Active and passive
Odometer	Travelled distance
Data-logger	For position, velocity, and time (NEO-M8N)
¹ For NEO-M8M/Q	

Electrical data

Supply voltage	1.65 V to 3.6 V (NEO-M8M) 2.7 V to 3.6 V (NEO-M8N/Q)
Power consumption ²	23 mA @ 3.0 V (continuous) 5 mA @ 3.0 V Power Save Mode (1 Hz, GPS only)
Backup Supply	1.4 to 3.6 V

² NEO-M8M

Interfaces

Serial interfaces	1 UART 1 USBV2.0 full speed 12 Mbit/s 1 SPI (optional) 1 DDC (I ² C compliant)
Digital I/O	Configurable timepulse 1 EXTINT input for Wakeup
Timepulse	Configurable 0.25 Hz to 10 MHz
Protocols	NMEA, UBX binary, RTCM

Package

Pinout

24 pin LCC (Leadless Chip Carrier): 12.2 x 16.0 x 2.4 mm, 1.6 g

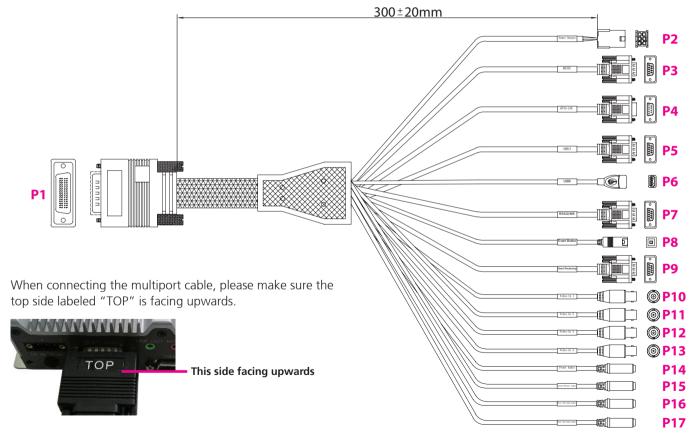
13	GND		GND	12
14	ANT_ON	/Reserved	RF_IN	11
15	Reserved	l	GND	10
16	Reserved	l	VCC_RF	9
17	Reserved	l	RESET_N	8
		NEO-M8	3	
18	SDA	Top View	VDD_USB	7
19	SCL	iop view	USB_DP	6
20	TxD		USB_DM	5
21	RxD		EXTINT	4
22	V_BCKP		TIMEPULSE	3
23	VCC		D_SEL	2
24	GND		Reserved	1

Environmental data, quality & reliability

Operating temp.	–40° C to 85° C	
Storage temp.	–40° C to 85° C (NEO-M8N/Q) –40° C to 105° C (NEO-M8M)	
RoHS compliant (lead-free)		
Qualification according to ISO 16750		
Manufactured and fully tested in ISO/TS 16949 certified production sites		
Uses u-blox M8 chips qualified according to AEC-Q100		

Appendix C: Pin Definition for the Multiport Cable

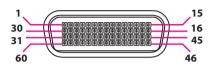
The multiport consists of a 60-pin connector (P1) and multiple output connectors. The tables in this appendix list the pin signals of the P1 connector and its corresponding pin signals to the output connectors.



CAUTION!



P1 Connector Pinout



P2 to P17 Connector Pinouts Power Output Connector

Connector type: 2x3 6-pin header Connector location: P2

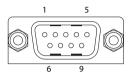


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P1 Pin	P2 Pin	Definition
1	2	OUT_12V
30	2	OUT_12V
31	5	GND
60	5	GND
	1, 3, 4, 6	NC

RS232 Connector

Connector type: DB9, Male Connector location: P3

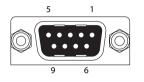


P1 Pin	P3 Pin	Definition
29	1	SP_DCD_3
28	2	SP_RXD_3
3	3	SP_TXD_3
2	4	SP_DTR_3
22	5	ISO_GND
33	6	SP_DSR_3
58	7	SP_RTS_3
32	8	SP_CTS_3
59	9	SP_RI_3



GPIO + CAN Bus 2.0B Connector

Connector type: DB9, Female Connector location: P4

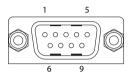


-

P1 Pin	P4 Pin	Definition
4	1	GPIO1
5	2	GPIO2
26	3	GPIO3
27	4	GPIO4
23	5	ISO_GND
34	6	GPIO5
37	7	CAN1_H
38	8	CAN1_L
35	9	GPIO6

OBDII Connector

Connector type: DB9, Male Connector location: P5

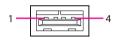


P1 Pin	P5 Pin	Definition
39	3	CAN_M_L
50	4	C1708_1_L
24	5	ISO_GND
40	8	CAN_M_H
51	9	C1708_1_H
	1, 2, 6, 7	NC

USB Connector

-

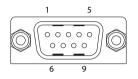
Connector type: USB Female, Type A Connector location: P6



P1 Pin	P6 Pin	Definition
6	1	USB1_POWER (+5V)
7	2	USB_2N_L (-)
8	3	USB_2P_L (+)
9	4	USB_GND (GND)

RS422/485 Connector

Connector type: DB9, Male Connector location: P7



P1 Pin	P7 Pin	Definition
21	1	RS485_+
20	2	RS485
11	3	RS422_TX+
10	4	RS422_TX-
25	5	ISO_GND
	6, 7, 8, 9	NC

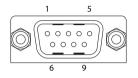


Reset Button

Connector location: P8



Connector type: DB9, Male Connector location: P9



P1 Pin	P9 Pin	Definition
52	1	DIRECTION
53	3	ODOMETER
54	5	1PPS
23	6	ISO_GND
	2, 4, 7, 8, 9	NC

P1 Pin	P8 Pin	Definition
41	1	Rear Panic (+)
22	2	ISO_GND (-)



A/V1 Jack

Connector type: BNC Connector location: P10



P1 Pin	P10 Pin	Definition
56	1	CAP1_A (+)
22	2	ISO_GND (-)

A/V2 Jack

Connector type: BNC Connector location: P11



P1 Pin	P11 Pin	Definition
57	1	CAP1_B (+)
23	2	ISO_GND (-)



A/V3 Jack

Connector type: RCA Connector location: P12



P1 Pin	P12 Pin	Definition
36	1	CAP2_A (+)
24	2	ISO_GND (-)

A/V4 Jack

Connector type: RCA Connector location: P13



P1 Pin	P13 Pin	Definition
55	1	CAP2_B (+)
25	2	ISO_GND (-)



Front Audio

Connector type: TRS 3.5mm Connector location: P14



P1 Pin	P14 Pin	Definition
12	1	AGND
13	2	FRONT_L_C
15	4	Jack Detection
14	5	FRONT_R_C

Center Audio

Connector type: TRS 3.5mm Connector location: P15



P1 Pin	P15 Pin	Definition
19	1	AGND
17	2	CEN_C
16	4	Jack Detection
18	5	LFE_C



Surround Audio

Connector type: TRS 3.5mm Connector location: P16



P1 Pin	P16 Pin	Definition
42	1	AGND
43	2	SURR_OUT_L_C
45	4	Jack Detection
44	5	SURR_OUT_R_C

Rear Audio

Connector type: TRS 3.5mm Connector location: P17

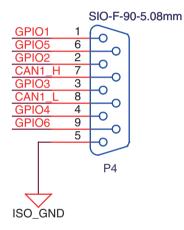


P1 Pin	P17 Pin	Definition
49	1	AGND
48	2	SIDE_L_C
46	4	Jack Detection
47	5	SIDE_R_C



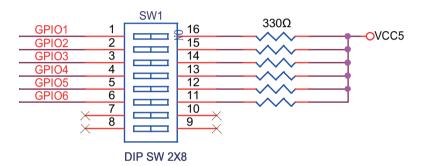
Appendix D: Signal Connection of DI/DO

GPIO Pinout Description



Note: By default, pin 1, 2 and 3 are configured for GPO, while pin 4, 5 and 6 are configured for GPI.

SW1 Setting



GPIO (SW1)		
On	Pull up VCC5	
Off	Don't Care	

Default Settings:

GPIO (SW1)			
SW1.1~SW1.6	Pull up VCC5		

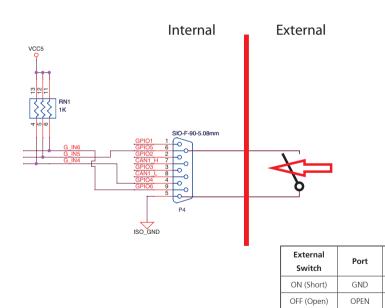


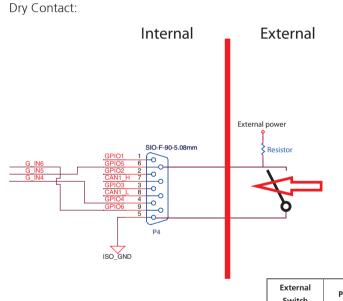
Digital Input

P4 connector for GPI signal (digital signal input) The P4 has 3 digital input channels by default.

Wet Contact (default) The GPI signals have a pull up resistor to 5V internally.

The figure below shows how to connect an external output source to one of the input channel.





External Switch	Port	GPI Register
ON (Short)	GND	0
OFF (Open)	HIGH	1

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Register

0



Digital Output

P4 connector for GPO signal (digital signal output) The P4 has 3 digital output channels by default. The signal connection of P4 support two connected methods for output signal type.

The output signal has two states, one is low level (driven to 0V from GPO signal) other is open (high voltage is provided from external device).

Wet Contact (default)

The SW1 needs to switch to "ON" state. The GPO signal will have a pull up resistor to 5V internally when you switch "SW1" to "ON" state. The output signal has two states, one is low level (driven to 0V from GPO signal) other is high level (driven to 5V from GPO signal).

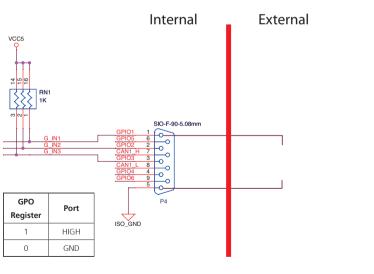
The figure below shows how to connect an external input source to one of the output channel.

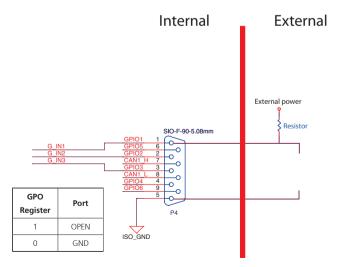


Each channel can accept 3~24Vdc voltage. And it is able to drive 150mA current for low level.

The SW1 needs to switch to "OFF" state. The GPO signal will no have a pull up resistor internally when you switch "SW1" to "OFF" state.

The figure below shows how to connect an external input source to one of the output channel.





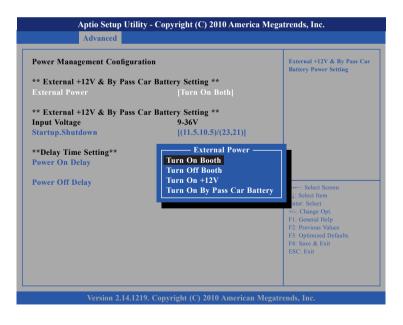


Appendix E: Vehicle Power Management Setup

External Power Output Setting

VTC 1010 has four modes for external power output setting.

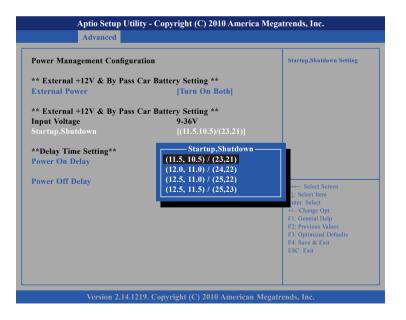
- 1. External +12V and By Pass Car Battery Turn On Simultaneously
- 2. External +12V and By Pass Car Battery Turn Off Simultaneously
- 3. External +12V Turn On Only
- 4. By Pass Car Battery Turn On Only



Startup and Shutdown Voltage Setting

Set the startup voltage to 11.5V or 23V and the shutdown voltage to 10.5V or 21V If the input voltage is 12V: the startup voltage to 11.5V and the shutdown voltage to 10.5V.

If the input voltage is 24V: the startup voltage to 23V and the shutdown voltage to 21V.



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Set the startup voltage to 12.0V or 24V and the shutdown voltage to 11.0V or 22V

If the input voltage is 12V: the startup voltage to 12V and the shutdown voltage to 11V.

If the input voltage is 24V: the startup voltage to 24V and the shutdown voltage to 22V.

		Startup,Shutdown Setting
Power Management Configuration		Startup, Snutuown Setting
* External +12V & By Pass	Car Battery Setting **	
External Power	[Turn On Both]	
* External +12V & By Pass	Car Battery Setting **	
nput Voltage	9-36V	
Startup.Shutdown	[(11.5.10.5)/(23,21)]	
*Delay Time Setting**	Startup,Shutdown —	
ower On Delay	(11.5, 10.5) / (23,21)	
	(12.0, 11.0) / (24,22)	
ower Off Delay	(12.5, 11.0) / (25,22) (12.5, 11.5) / (25,23)	→←: Select Screen
	(12:3, 11:3) / (23,23)	↓: Select Item inter: Select
		+/-: Change Opt.
		F1: General Help
		F2: Previous Values F3: Optimized Defaults
		F4: Save & Exit
		ESC: Exit

Set the startup voltage to 12.5V or 25V and the shutdown voltage to 11.0V or 22V

If the input voltage is 12V: the startup voltage to 12.5V and the shutdown voltage to 11V.

If the input voltage is 24V: the startup voltage to 25V and the shutdown voltage to 22V.



.

Set the startup voltage to 12.5V or 25V and the shutdown voltage to 11.0V or 22V

If the input voltage is 12V: the startup voltage to 12.5V and the shutdown voltage to 11.5V.

If the input voltage is 24V: the startup voltage to 25V and the shutdown voltage to 23V.

Power Management Configuration		Startup,Shutdown Setting
* External +12V & By Pass C External Power	ar Battery Setting ** [Turn On Both]	
r* External +12V & By Pass C nput Voltage Startup.Shutdown	ar Battery Setting ** 9-36V [(11.5.10.5)/(23,21)]	
Delay Time Setting Power On Delay Power Off Delay	Startup,Shutdown (11.5, 10.5) / (23,21) (12.0, 11.0) / (24,22) (12.5, 11.0) / (25,22) (12.5, 11.5) / (25,23)	+ Select Screen 1: Select Item nter: Select +
		F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit

Power-on Delay Setting

Disable Power-on Delay

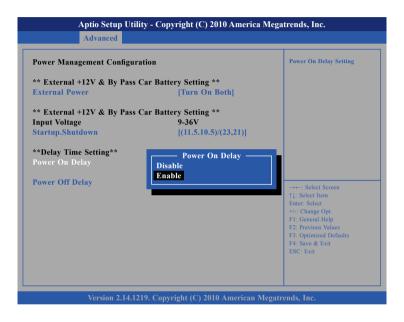
Power Management Configuration		External +12V & By Pass Car Battery Poewer Setting
** External +12V & By Pass	Car Battery Setting **	
External Power	[Turn On Both]	
** External +12V & By Pass	Car Battery Setting **	
Input Voltage	9-36V	
Startup.Shutdown	[(11.5.10.5)/(23,21)]	
Delay Time Setting		
Power On Delay	[Disable]	
Power Off Delay	[Disable]	→←' Select Screen
		→←: Select Screen ↑1: Select Item
		Enter: Select
		+/-: Change Opt. F1: General Help
		F2: Previous Values
		F3: Optimized Defaults
		F4: Save & Exit ESC: Exit
		LOC. LAN

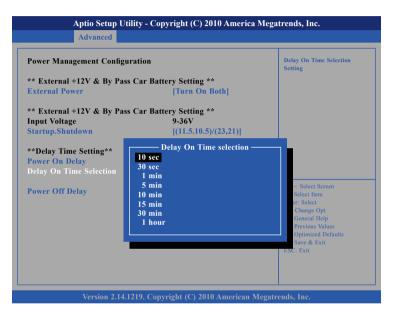


Enable Power-on Delay

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Delay time can be set at 10sec/30sec/1min./5min./10min./15min./30min./1hour.







Power-off Delay Setting

Disable Power-off Delay

- -

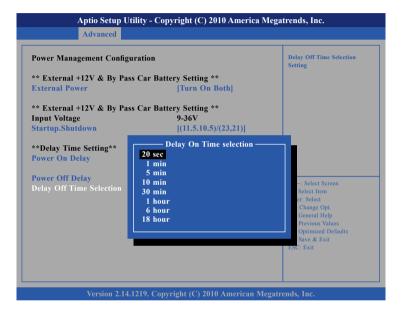
Power Management Configuration		External +12V & By Pass Car Battery Poewer Setting
** External +12V & By Pass	Car Battery Setting **	
External Power	[Turn On Both]	
** External +12V & By Pass	Car Battery Setting **	
Input Voltage	9-36V	
Startup.Shutdown	[(11.5.10.5)/(23,21)]	
Delay Time Setting		
Power On Delay	[Disable]	
Power Off Delay	[Disable]	→←' Select Screen
		↑⊥: Select Item
		Enter: Select
		+/-: Change Opt.
		F1: General Help F2: Previous Values
		F3: Optimized Defaults
		F4: Save & Exit
		ESC: Exit

Enable Power-off Delay

Delay time can be set at 20sec/1min./5min./10min./30min./1hour/6hour/ 18hour.

Power Management Configu	ration	Delay Off Delay Setting
** External +12V & By Pass External Power	s Car Battery Setting ** [Turn On Both]	
** External +12V & By Pass	s Car Battery Setting **	
Input Voltage Startup.Shutdown	9-36V [(11.5.10.5)/(23,21)]	
Delay Time Setting Power On Delay Power Off Delay	Power Off Delay —— Disable Enable	→: Select Screen 1: Select Item Enter: Select +/-: Change Opt. F1: General Help F2: Previous Values F3: Optimized Defaults F4: Save & Exit ESC: Exit







Appendix F: Power Consumption

OS: Windows 8 Burn-in Software: Version 6.0 Device: 2G DDR3L and SSD

Idle Mode	Burn-in Mode	S3	S4	S5
494mA/12V	0.92A/12V	88mA/12V	6mA/12V	6mA/12V
6W	11W	1.1W	0.1W	0.1W